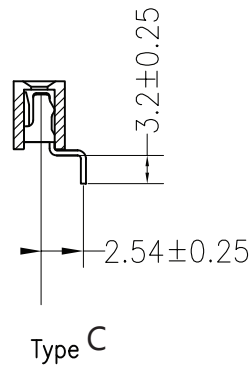
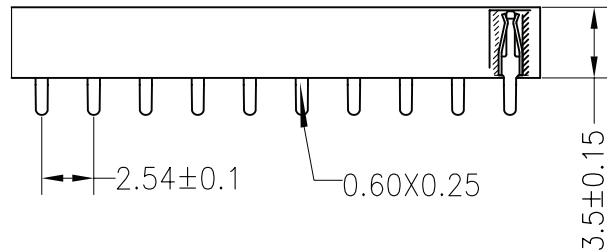
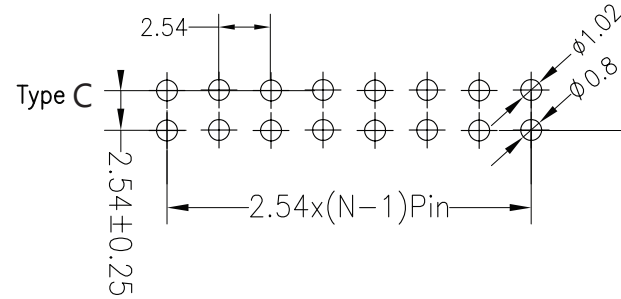
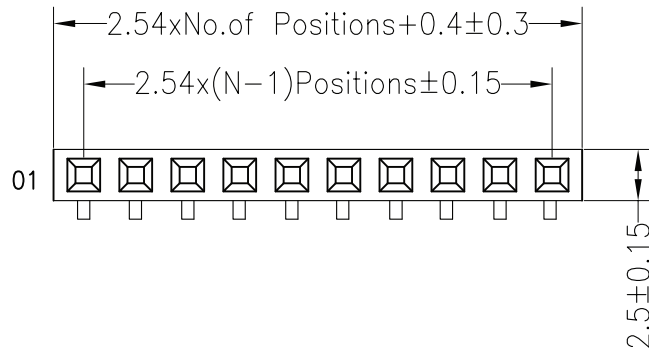


Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE±0.05)



SPECIFICATIONS

Rated Current:3.0AMP

Contact Resistance:20mΩ Max

Withstand Voltage:1000V AC/DC

Insulation Resistance:1000MΩ Min

Operation Temperature:−40°C to +105°C

Contact Material:Brass

Contact Plating:Au or Sn Over Ni

Insulator Material:Polyester(UL94V-0)

Standard: PA6T

Max.Processing Temp: 230°C for 30–60 seconds
(260°C for 10 seconds)

General description of ordering code

FAMILY	PITCH	N° ROWS	N° PIN P.R.	VERSION	CLIP PLATING	HEIGHT	OPTION	PACKAGE	TYPE
FH	254	1	XX	D [straight]	F [flash gold]	035	00 [Standard]	T [tube]	C
					G [gold 10u]			V [tray-]	



euro-conn



UL US
FILE N. E356435

UNITS: mm

SHEET SIZE: ISO A4

SCALE:

> 0 ~ 3

> 3 ~ 18

> 18 ~ 50

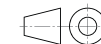
> 50 ~ 120

± 0.12

± 0.15

± 0.3

± 0.5



First angle projection

HEADER